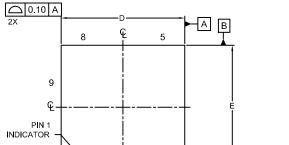


WDFN9 3.3x3.3, 0.65P

CASE 511EB **ISSUE B**

DATE 21 JUL 2021



4

NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETERS
- COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.
- DIMENSIONS D1, D2, E1 AND E2 DO NOT
- INCLUDE MOLD FLASH.
 SEATING PLANE IS DEFINED BY THE TERMINALS. "A1" IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

DIM MIN

Α A1

e/2

k1

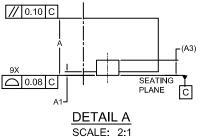
L1

L4

0.73

0.10

0.40



А3 0.20 RE b 0.30 b2 0.37 0.42 0.47 3.30 D 3.40 3.20 D1 2.41 2.51 2.31 D2 1.58 1.68 1 78 D3 2.31 2.41 2.51 Ε 3.20 3.30 3.40 E1 1.50 1.60 1.70 E2 0.84 0.94 1.04 E3 0.25 0.20 E4 0.35 0.45 0.55 е 0.650 BSC

0.325 BSC

0.75 REF

0.45 REF

0.83

0.20

0.50

0.93

0.30

0.60

UNIT IN MILLIMETER

0.70

0.00

NOM

0.75

0.02

MAX

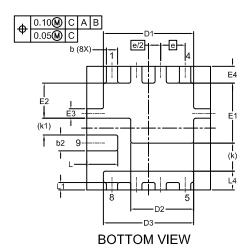
0.80

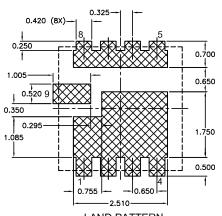
0.05

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FRONT VIEW

TOP VIEW





LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC MARKING DIAGRAM*

XXXXXX XXXXXX **AWLYWW** XXXX = Specific Device Code

0.10 B

SEE DETAIL A

= Assembly Location

= Work Week

WL = Wafer Lot = Year

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*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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